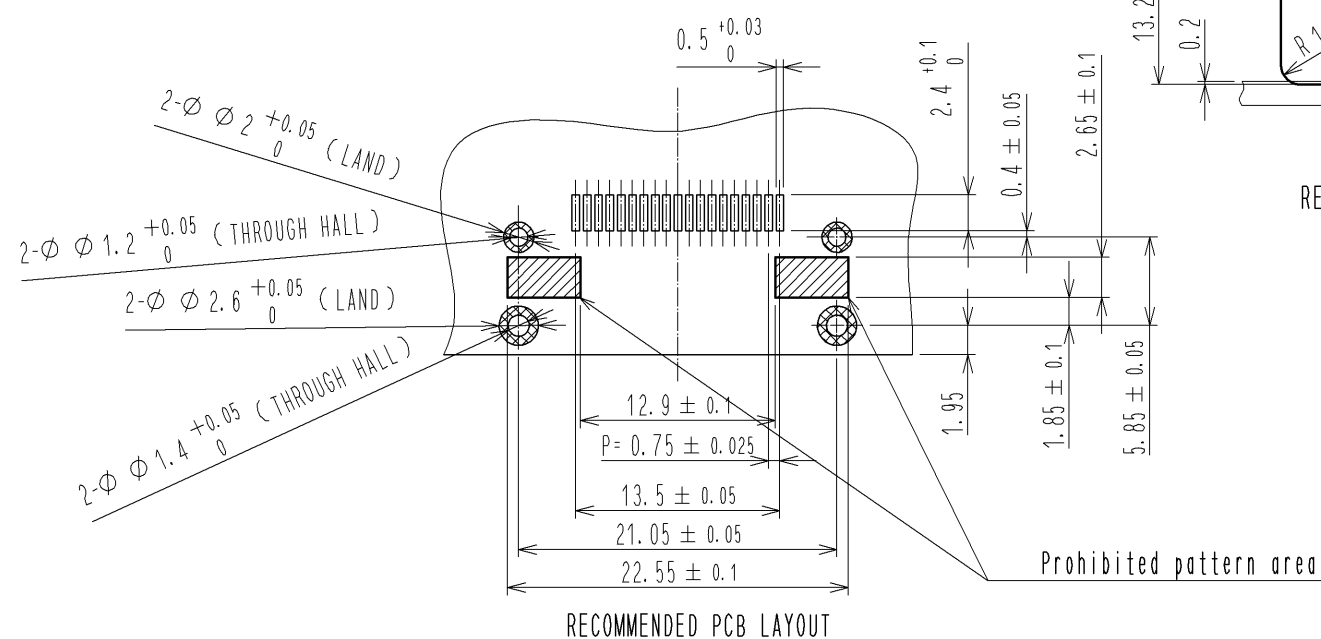
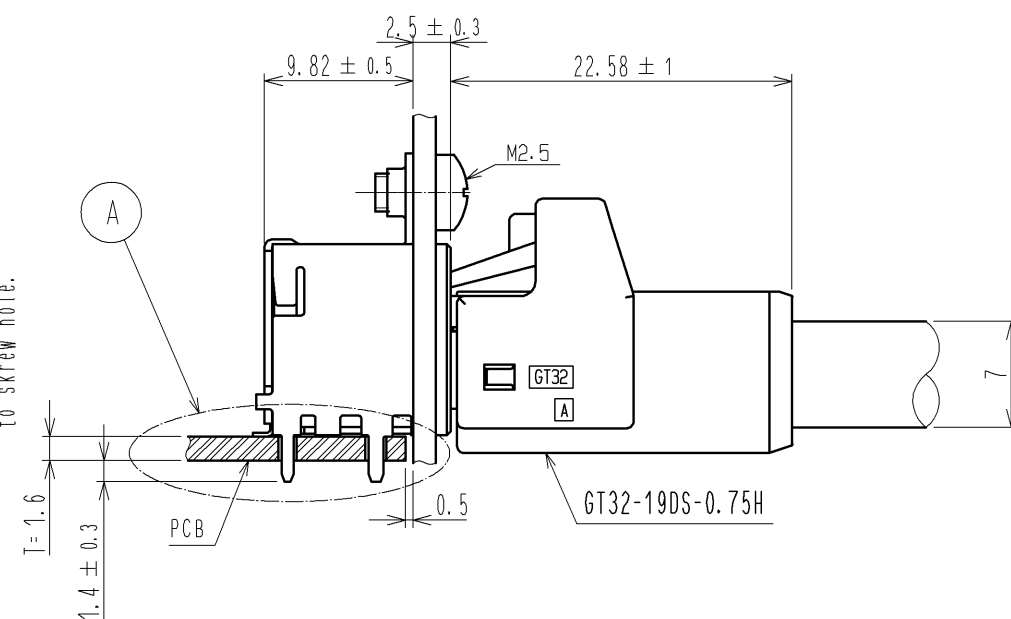
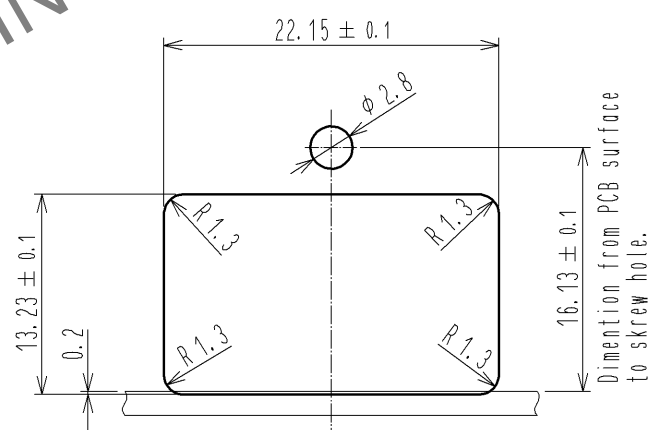
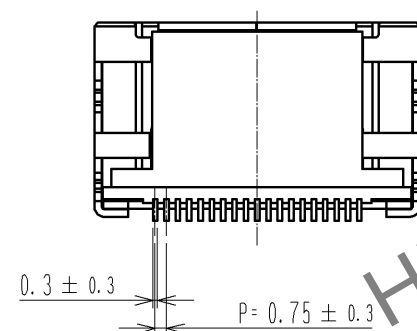
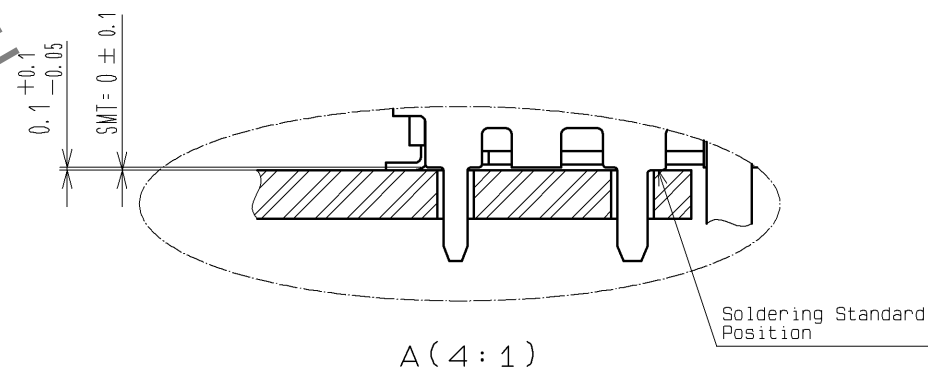
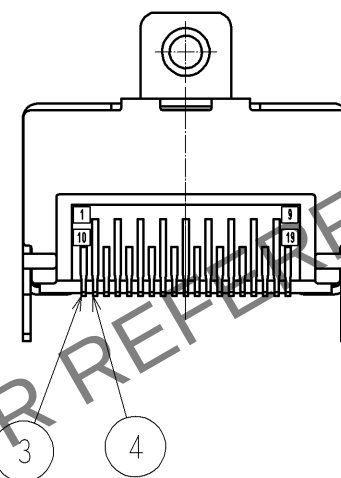
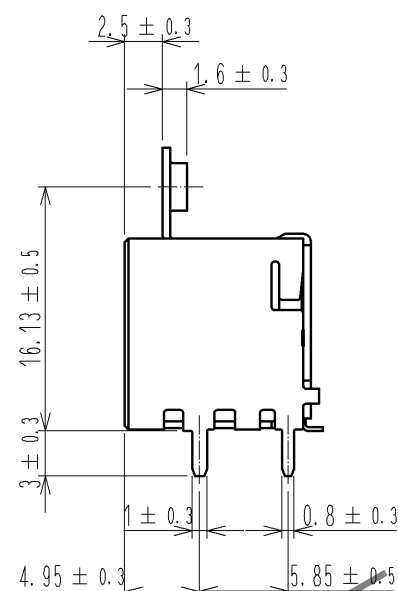
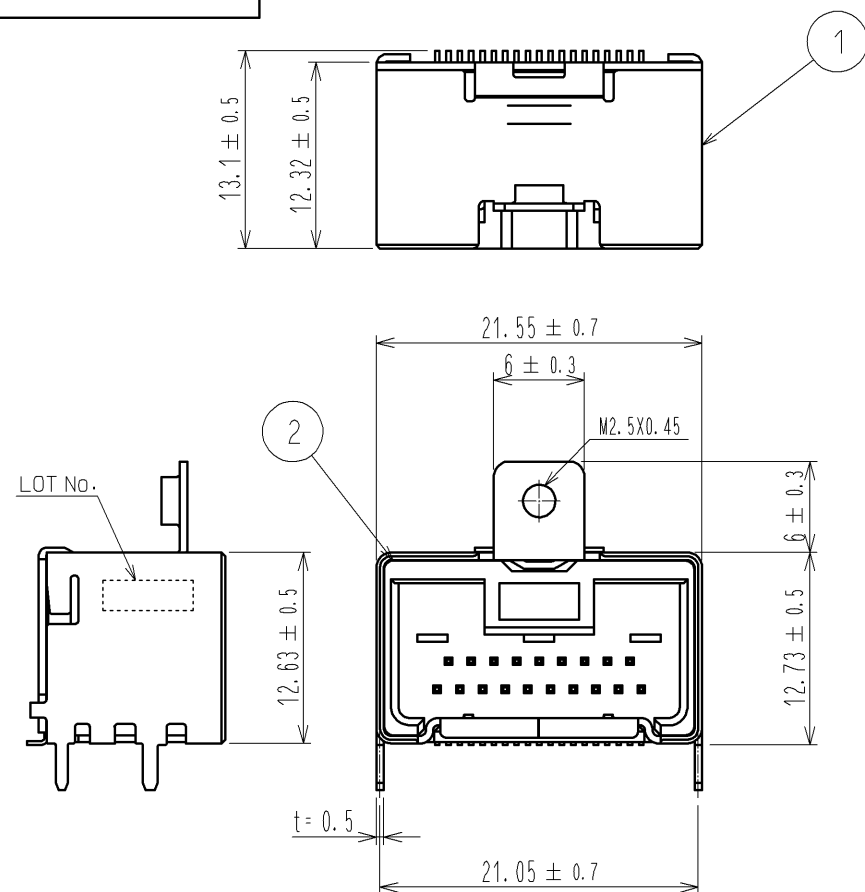
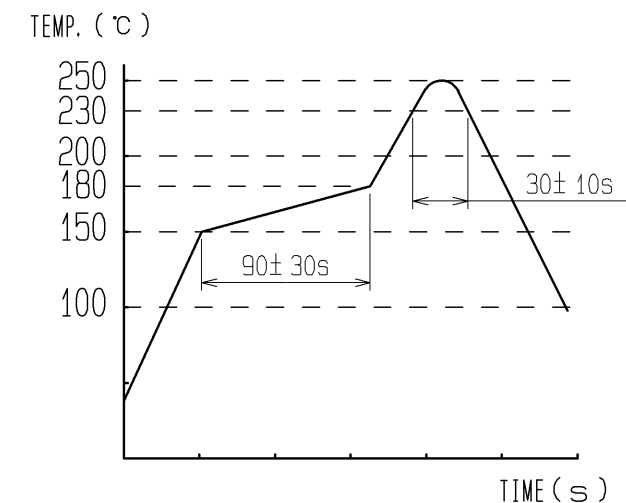
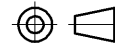


PEAK TEMPERATURE: 250°C
230°C MIN. FOR 20 TO 40 SECONDS.
PREHEATING AREA 150~180°C FOR 60 TO 120 SECONDS.
HAND SOLDERING: 280-300°C, 2S MAX.
CONTACT COPLANARITY: 0.1mm MAX.
RECOMMENDED THICKNESS OF PCB: 1.6mm
RECOMMENDED THICKNESS OF SOLDERING PASTE: 0.15mm



2	PA	GRAY		4	BRASS	TIN PLATED		
1	COPPER ALLOY	TIN PLATED		3	BRASS	TIN PLATED		
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS		
UNITS mm 		SCALE 2 : 1	 COUNT 1	DESCRIPTION OF REVISIONS DIS-T-004064		DESIGNED NK. IKUTA	CHECKED TS. KUBOTA	DATE 14. 09. 1
HIROSE ELECTRIC CO. , LTD.		APPROVED : AR. SHIRAI		12. 03. 02	DRAWING NO. EDC3-168826-00			
		CHECKED : NH. NAKATA		12. 03. 01	PART NO. GT32-19DP-0.75H			
		DESIGNED : MH. SHOUJI		12. 02. 20	CODE NO. CL782-0009-3-00			
		DRAWN : MH. SHOUJI		12. 02. 20				

PACKAGE SPECIFICATIONS

- ①. Place the connectors into the tray. (Cf. Figure of tray shape)
QTY per tray: 77pcs
- ②. Put the tray for six steps in turn and wind up a PP band.
Top(the sixth step) is an empty tray.
- ③. Put it in a cardboard box (W=267 H=126 D=365)
QTY per cardboard: 385 pcs

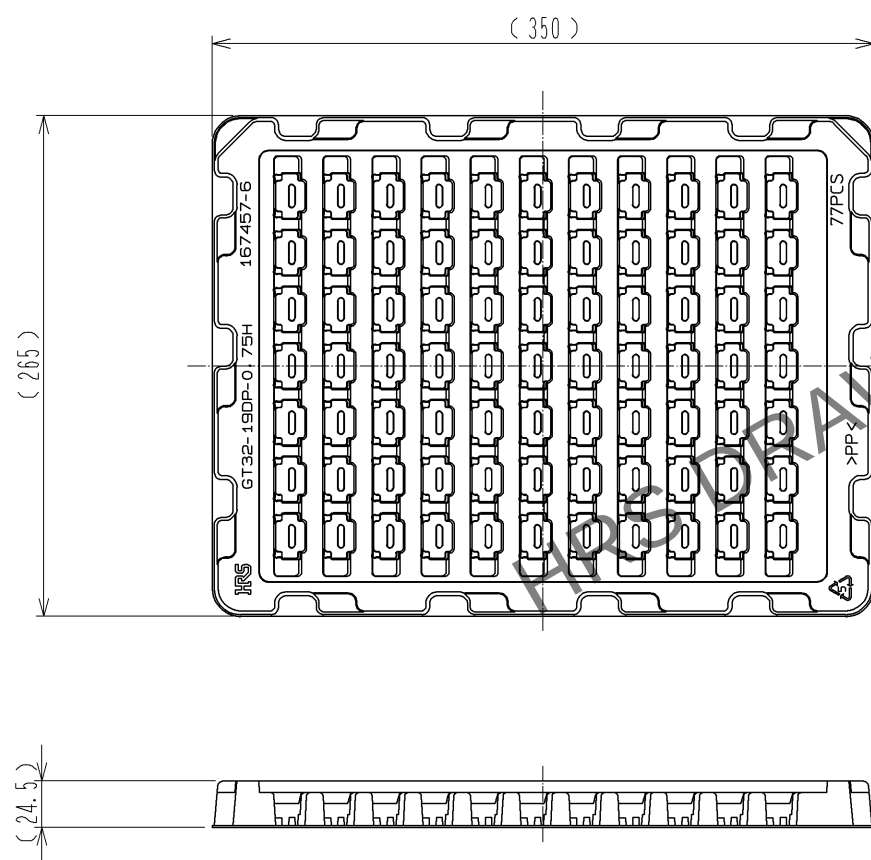


Figure of tray shape

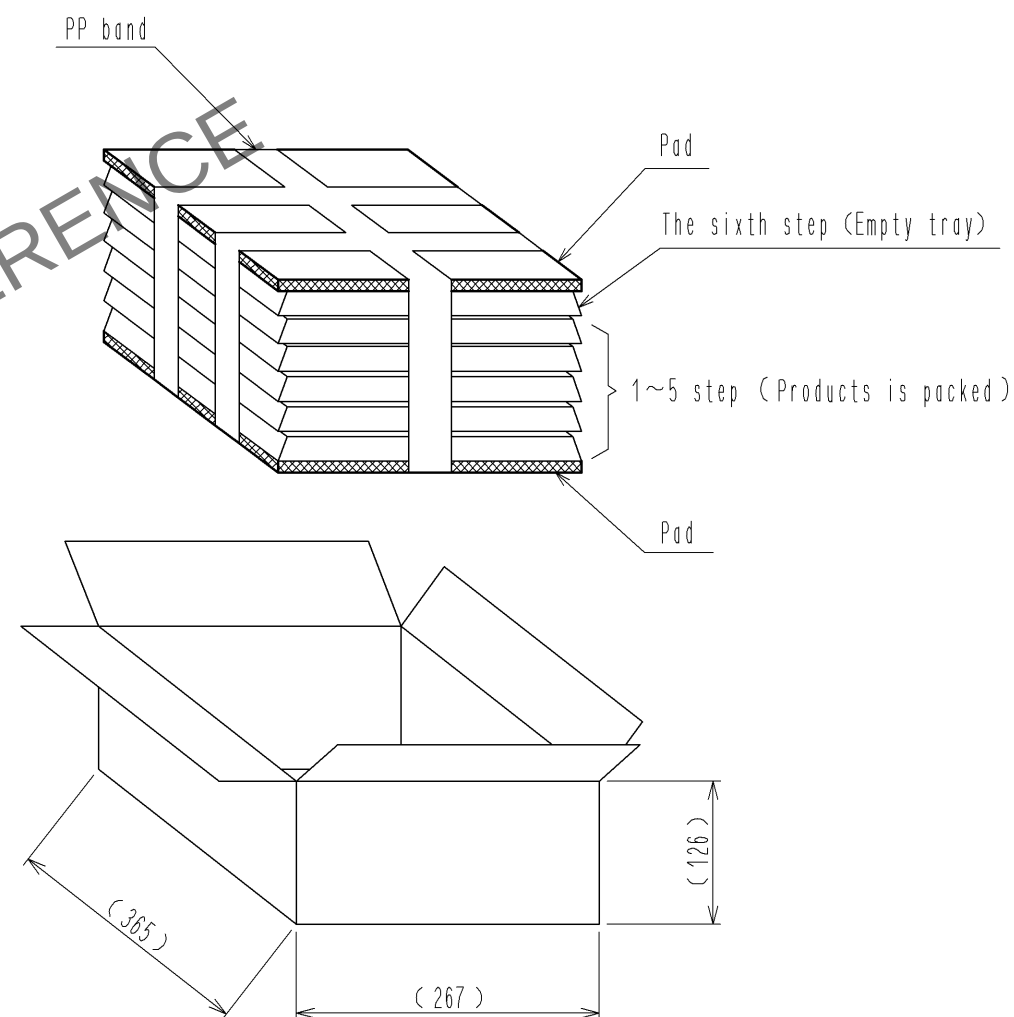


Figure of packing

HRS

図番: EDC3-168826-00
製品名: GT32-19DP-0.75H
製品コード: CL782-0009-3-00

3/2